Electronic Patent Application Fee Transmittal						
Application Number:	10581165					
Filing Date:	31-May-2006					
Title of Invention:	Ult	SI-May-2006 Jitra-Low Dielectrics Film for Copper Interconnect Hee-Woo Rhee Howard C. Lee/Jennifer Hardy 930086-2027				
First Named Inventor/Applicant Name:	Hee-Woo Rhee					
Filer:	Howard C. Lee/Jennifer Hardy					
Attorney Docket Number:	930086-2027					
Filed as Large Entity						
U.S. National Stage under 35 USC 371 Filing	Fee	s				
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)	
Basic Filing:						
Pages:						
Claims:						
Miscellaneous-Filing:						
Petition:						
Patent-Appeals-and-Interference:						
Post-Allowance-and-Post-Issuance:						
Extension-of-Time:						
Extension - 1 month with \$0 paid		1251	1	130	130	

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)				
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Submission-Information Disclosure Stmt	1806	1	180	180				
	Tot	310						